, 2-9-08 Al 755	Express Mail Label No. EV58271390/UB 23781
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To the Director of the United States 103	the attached original documents or copy thereof.
Name of conveying party(ies):     Chun-Hyun CHO	2. Name and address of receiving party(ies):  Name: SAMSUNG ELECTRONICS CO., LTD.
	Address: 416 Maetan-dong, Yeongtong-gu
Additional names(s) of conveying party(ies)	No
3. Nature of conveyance:	
☑ Assignment ☐ Merger	
☐ Security Agreement ☐ Change of Nar	me City: Suwon-si State/Prov.: Gyeonggi-do
Other	Country: KOREA ZIP:
Execution Date: February 2, 2005	Additional name(s) & address(es) ☐ Yes ☒ No
<ol> <li>Application number(s) or patent numbers(s):</li> <li>If this document is being filed together with a new app</li> <li>Patent Application No.</li> <li>Filing date</li> </ol>	/ D / 523 78/ lication, the execution date of the application is: February 2, 2005  B. Patent No.(s)
Additional n	umbers
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Jae Y. Park	7. Total fee (37 CFR 3.41):\$ 40.00
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Jae Y. Park	February 9, 2005
Name of Person Signing	Signature  Cluding cover sheet, attachments, and
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## **ASSIGNMENT**

WHEREAS I, Chun-Hyun CHO(hereinafter referred to as "ASSIGNOR") of 107-705

Doosan Donga Apt., Gwonseon-dong, Gwonseon-gu, Suwon-si, Gyeonggi-do, KOREA
have invented certain new and useful improvements in:

## OPTICAL MEMBER, BACKLIGHT ASSEMBLY AND LIQUID CRYSTAL DISPLAY DEVICE USING THE SAME

which claims priority to Korean Application No. 2002-0047716, filed August 13, 2002, and for which I am about to file or have filed an application for Letters Patent of the United States;

AND WHEREAS, SAMSUNG ELECTRONICS CO., LTD. (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of KOREA, having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and I do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that I will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

PATENT REEL: 016980 FRAME: 0090

The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Chun Hyun CHO
Chun-Hyun CHO
L.S. Date: 2005 . 02 . 02

-2-

RECORDED: 02/09/2005